



#### **DUAL N-CHANNEL ENHANCEMENT MODE MOSFET**

# **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> Max	I <sub>D</sub> Max T <sub>A</sub> = +25°C
001/	40mΩ @ V <sub>GS</sub> = 4.5V	5.0A
30V	75mΩ @ V <sub>GS</sub> = 2.5V	3.6A

## **Features and Benefits**

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMN3055LFDBQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

# **Description and Applications**

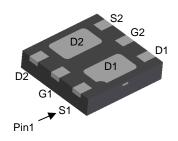
This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP, and is ideal for use in:

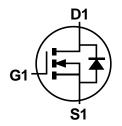
- Battery Charging
- Power Management Functions
- DC-DC Converters
- Portable Power Adaptors

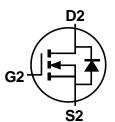
#### **Mechanical Data**

- Case: U-DFN2020-6
- Case Material: Molded Plastic, "Green" Molding Compound UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper Leadframe.
  Solderable per MIL-STD-202, Method 208 (4)
- Weight: 0.0065 grams (Approximate)

U-DFN2020-6 (Type B)







### **Ordering Information** (Note 4)

Part Number	Case	Packaging
DMN3055LFDBQ-7	U-DFN2020-6 (Type B)	3,000/Tape & Reel
DMN3055LFDBQ-13	U-DFN2020-6 (Type B)	10,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/



# **Marking Information**



M6 = Product Type Marking Code YWX = Date Code Marking Y = Year (ex: 1 = 2021) W = Week (ex: a = Week 27; z Represents Week 52 and 53) X = Internal Code (ex: U = Monday)

### Date Code Key

Year	2020	2021	2022	2023	2024	2025	2026	2027	2028	2029	2030	2031
Code	0	1	2	3	4	5	6	7	8	9	0	1

Week	1-26	27-52	53
Code	A-Z	a-z	Z

Internal Code	Sun	Mon	Tue	Wed	Thu	Fri	Sat
Code	T	U	V	W	X	Υ	Z



## **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Drain-Source Voltage			VDSS	30	V
Gate-Source Voltage			V <sub>GSS</sub>	±12	V
Continuous Drain Current (Note 6) VGS = 4.5V	lo	5.0 4.0	А		
Maximum Continuous Body Diode Forward Curre	nt (Note 6)	Is	1.5	Α	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1	%)	I <sub>DM</sub>	25	Α	
Avalanche Current (Note 7) L = 0.1mH	las	11	А		
Avalanche Energy (Note 7) L = 0.1mH			Eas	6	mJ

## **Thermal Characteristics**

Characteristic	Characteristic				
Total Power Dissipation (Note 5)	T <sub>A</sub> = +25°C	Pp	0.81	W	
Total Fower Dissipation (Note 3)	T <sub>A</sub> = +70°C	PD	0.52		
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	ReJA	132	°C/W	
Thermal Resistance, Junction to Ambient (Note 5)	t<10s	Көја	101		
Total Power Dissipation (Note 6)	T <sub>A</sub> = +25°C	Pp	1.36	W	
Total Fower Dissipation (Note o)	T <sub>A</sub> = +70°C	PD	0.87	v V	
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	Reja	83		
Thermal Resistance, Junction to Ambient (Note 6)	Көја	60	°C/W		
Thermal Resistance, Junction to Case (Note 6)	R <sub>0</sub> JC	10			
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C	

# **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

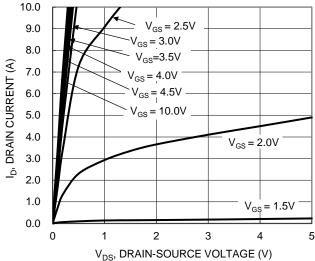
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	30	_	_	V	$V_{GS} = 0V, I_{D} = 250\mu A$	
Zero Gate Voltage Drain Current, TJ = +25°C	IDSS	_	_	1.0	μA	V <sub>DS</sub> = 30V, V <sub>GS</sub> = 0V	
Gate-Source Leakage	Igss	_	_	±100	nA	$V_{GS} = \pm 12V$ , $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	VGS(TH)	0.5	_	1.5	V	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$	
Static Drain-Source On-Resistance	0	_	32	40	mΩ	$V_{GS} = 4.5V, I_{D} = 3A$	
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	_	52	75	11112	Vgs = 2.5V, ID = 2A	
Diode Forward Voltage	VsD	_	0.8	1.2	V	V <sub>G</sub> S = 0V, I <sub>S</sub> = 2A	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	Ciss	1	458	_	pF	V 45V V 0V	
Output Capacitance	Coss	-	50	_	pF	V <sub>DS</sub> = 15V, V <sub>GS</sub> = 0V, f = 1.0MHz	
Reverse Transfer Capacitance	Crss	_	44	_	pF	1 = 1.0WI IZ	
Gate Resistance	Rg	_	2.1	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$	
Total Gate Charge (V <sub>GS</sub> = 10V)	Qg	_	11.2	_	nC		
Total Gate Charge (VGS = 4.5V)	Qg	_	5.3	_	nC	\ \ 45\\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	
Gate-Source Charge	Qgs	_	1.1	_	nC	V <sub>DS</sub> = 15V, I <sub>D</sub> = 4A	
Gate-Drain Charge	Qgd	_	1.8	_	nC	]	
Turn-On Delay Time	tD(ON)	_	1.8	_	ns		
Turn-On Rise Time	t <sub>R</sub>	_	2.6	_	ns	V <sub>DS</sub> = 15V, V <sub>GS</sub> = 10V,	
Turn-Off Delay Time	tD(OFF)	_	9.5	_	ns	$R_g = 6\Omega$ , $R_L = 3.75\Omega$	
Turn-Off Fall Time	t <sub>F</sub>	_	2.1	_	ns	]	
Reverse Recovery Time	trr	-	7.0	_	ns	1 0A 11/14 400A/	
Reverse Recovery Charge	Qrr	_	1.8	_	nC	I <sub>F</sub> = 3A, di/dt = 100A/μs	

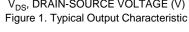
Notes:

- 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
- 7.  $I_{AS}$  and  $E_{AS}$  ratings are based on low frequency and duty cycles to keep  $T_J = +25$ °C.
- 8. Short duration pulse test used to minimize self-heating effect.
- 9. Guaranteed by design. Not subject to product testing.









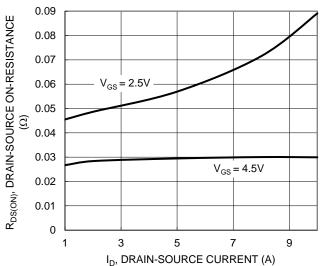


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

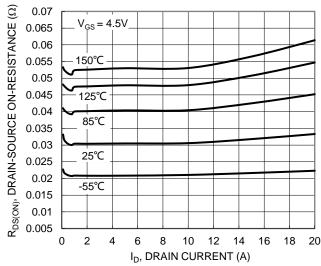


Figure 5 . Typical On-Resistance vs. Drain Current and Temperature

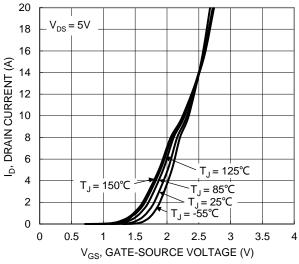


Figure 2. Typical Transfer Characteristic

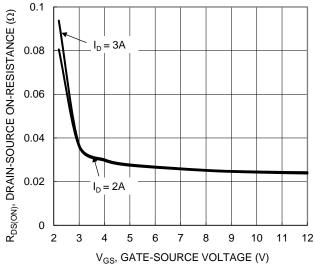


Figure 4 . Typical Transfer Characteristic

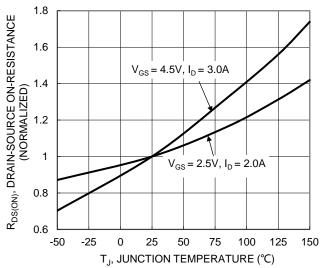


Figure 6. On-Resistance Variation with Temperature



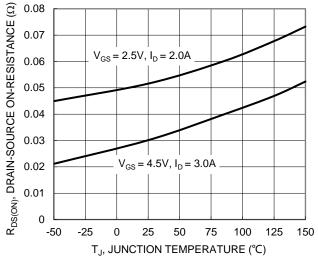


Figure 7. On-Resistance Variation with Temperature

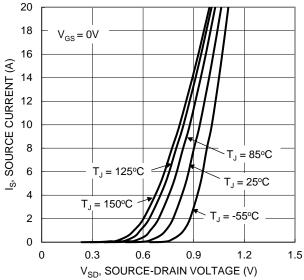


Figure 9. Diode Forward Voltage vs. Current

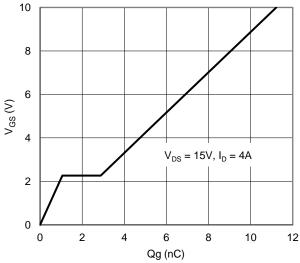


Figure 11. Gate Charge

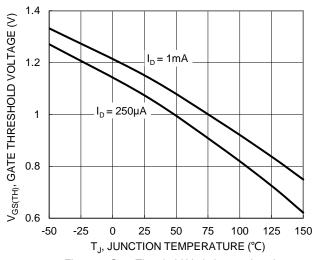
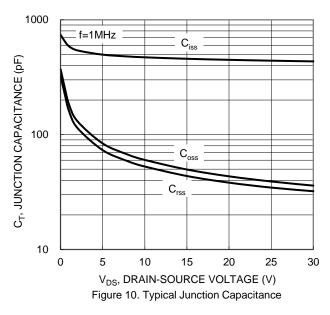


Figure 8. Gate Threshold Variation vs. Junction Temperature



 $\begin{array}{c} 100 \\ \hline R_{DS(ON)} \text{ Limited} \\ \hline \\ P_W = 100 \mu \text{s} \\ \hline \\ P$ 



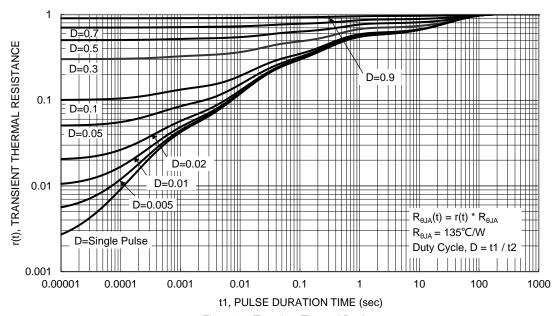


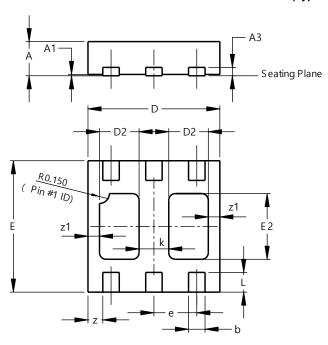
Figure 13. Transient Thermal Resistance



# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### U-DFN2020-6 (Type B)

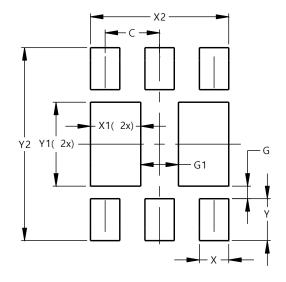


		2020-6	
	Тур		
Dim	Min Max		Тур
Α	0.545	0.605	0.575
A1	0.00	0.05	0.02
A3	-	-	0.13
b	0.20	0.30	0.25
D	1.95	2.075	2.00
D2	0.50	0.70	0.60
e	-	-	0.65
Е	1.95	2.075	2.00
E2	0.90	1.10	1.00
k	-	-	0.45
L	0.25	0.35	0.30
Z	-	-	0.225
z1	-	-	0.175
All	Dimens	ions in	mm

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### U-DFN2020-6 (Type B)



Dimensions	Value
	(in mm)
С	0.650
G	0.150
G1	0.450
Х	0.350
X1	0.600
X2	1.650
Y	0.500
Y1	1.000
Y2	2.300



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